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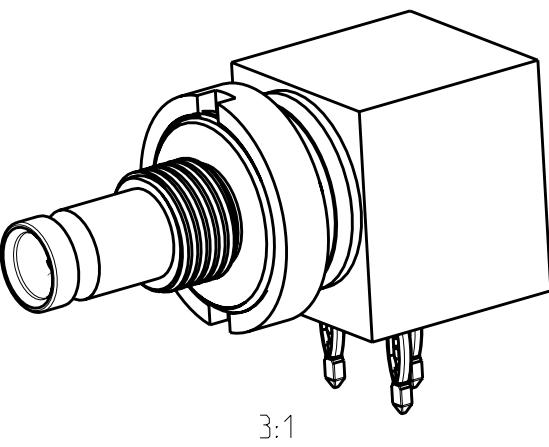
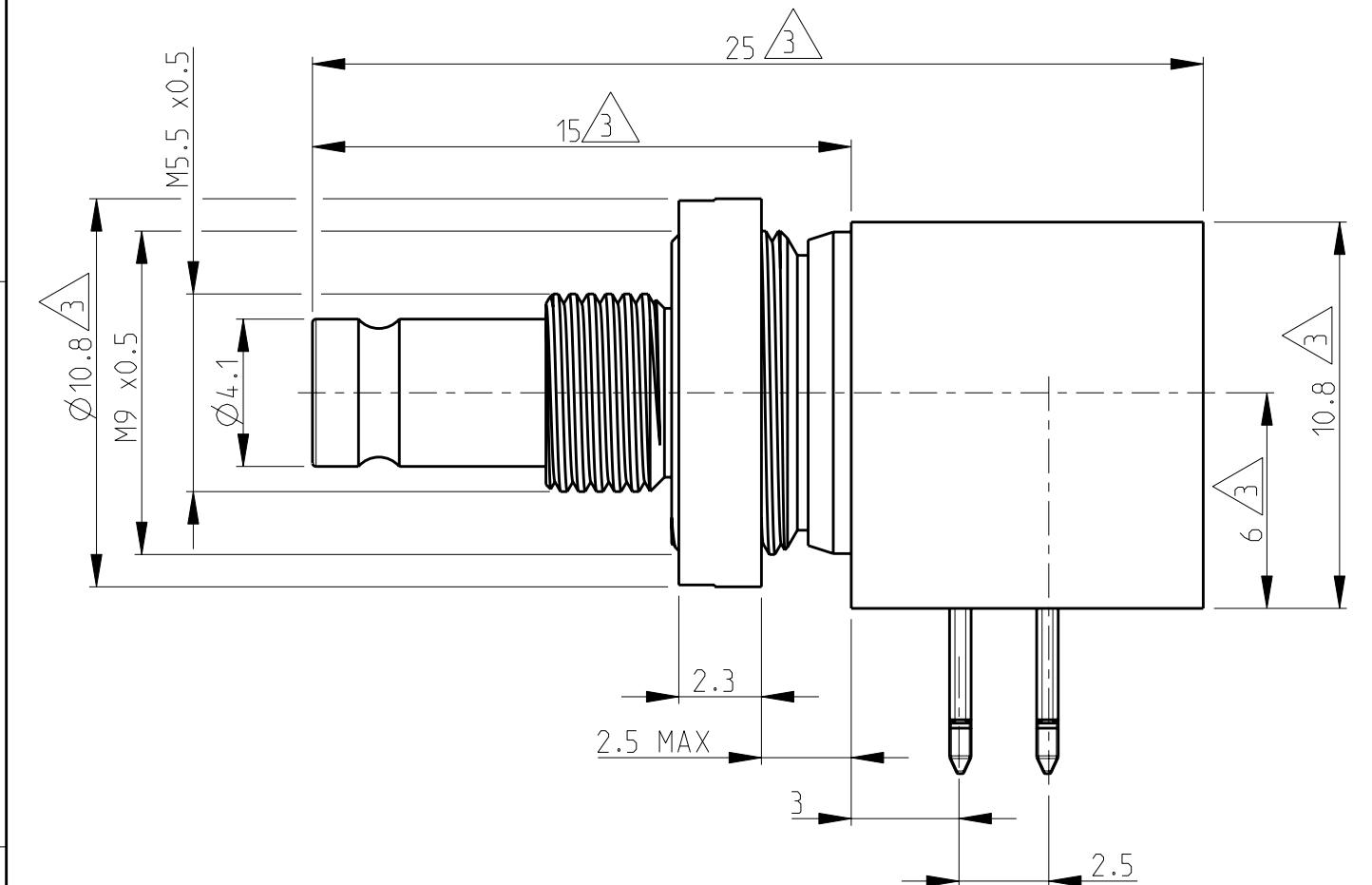
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2000

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REVISIONS					
P	LTR	DESCRIPTION	DATE	DWN	APVD
	A	SR10-0344-01	01AUG01	BL	KM
	B	ECR-07-028994	13AUG07	AN	DB

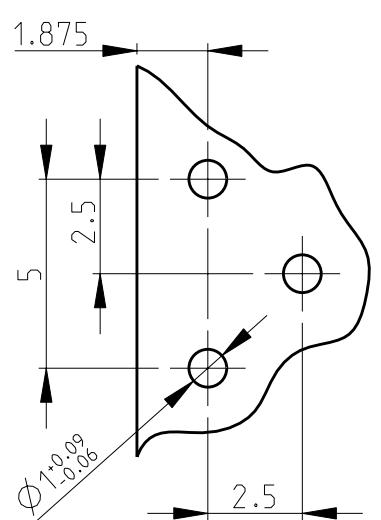


1) Mating face according to CECC 22230 and IEC 169-29

△ DIN ISO 8015; DIN ISO 2768-mH

△ Maximum dimension

Recommended PCB layout



Cross reference table

Old part number	TE part number	Description	Material	Plating
V23614-A1230-A1	8-1393670-7	Outer conductor	Brass	min. 0.1 µm Au over min. 2 µm NiP
		Dielectrics	PEEK/PTFE	-
		Center conductor	CuBe/Bronze	min. 0.1 µm Au over min. 2 µm NiP

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DIMENSIONS: mm		TOLERANCES UNLESS OTHERWISE SPECIFIED:		NAME Right angled jack 1.0/2.3 with press-in PCB connection
 0 PLC ± 1 PLC ± 2 PLC ± 3 PLC ± 4 PLC ANGLES ±		 PRODUCT SPEC 108-71032 APPLICATION SPEC -		
MATERIAL	FINISH	WEIGHT	DRAWING NO	RESTRICTED TO
-	-	-	A 3 00779 C-8-1393670-7	-
CUSTOMER DRAWING				SCALE
				1 OF 1
				REV B